



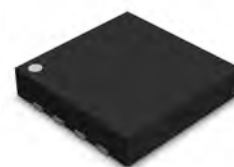
JIANGSU CHANGJING ELECTRONICS TECHNOLOGY CO., LTD.

DFNWB3×3-8L Plastic-Encapsulate MOSFETS

CJAE28SN06 N-Channel Power MOSFET

$V_{(BR)DSS}$	$R_{DS(on)}$ TYP	I_D
60 V	11.5mΩ@10V	28A
	15.0mΩ@4.5V	

DFNWB3×3-8L



DESCRIPTION

The CJAE28SN06 uses SGT technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

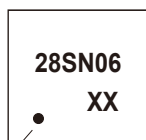
FEATURES

- High density cell design for ultra low $R_{DS(ON)}$
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

APPLICATIONS

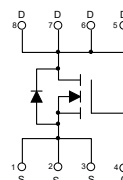
- Battery and loading switching

MARKING



28SN06= Part No.
Solid dot=Pin1 indicator.
XX=Code.

EQUIVALENT CIRCUIT



MAXIMUM RATINGS ($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current	I_D ①	28	A
Pulsed Drain Current	I_{DM} ②	112	A
Single Pulsed Avalanche Energy	E_{AS} ③	90	mJ
Power Dissipation	P_D ①	32	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$ ⑥	83.3	°C/W
Thermal Resistance from Junction to Case	$R_{\theta JC}$ ①	3.9	°C/W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55~+150	°C

PIN 1

MOSFET ELECTRICAL CHARACTERISTICS

$T_a=25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Test Condition		Min	Typ	Max	Unit
Off characteristics							
Drain-source breakdown voltage	V _{(BR) DSS}	V _{GS} = 0V, I _D =250μA		60			V
Zero gate voltage drain current	I _{DSS}	V _{DS} =48V, V _{GS} =0V	T _J =25℃			1.0	μA
			T _J =125℃			100	
Gate-body leakage current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V				±100	nA
On characteristics ^④							
Gate-threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA		1.0	1.6	2.5	V
Static drain-source on-sate resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A			11.5	14.5	mΩ
		V _{GS} =4.5V, I _D =10A			15.0	20.0	mΩ
Dynamic characteristics ^⑤							
Input capacitance	C _{iss}	V _{DS} =30V, V _{GS} =0V, f =1MHz			1083		pF
Output capacitance	C _{oss}				302		
Reverse transfer capacitance	C _{rss}				9.9		
Gate resistance	R _g	f =1MHz			3.6		Ω
Switching characteristics ^⑤							
Total gate charge	Q _g	V _{GS} =10V, V _{DS} =30V, I _D =12A			21.4		nC
Gate-source charge	Q _{gs}				2.5		
Gate-drain charge	Q _{gd}				4.6		
Turn-on delay time	t _{d(on)}	V _{DD} =30V, V _{GS} =10V, R _G =10Ω, R _L =2.3Ω			21.2		ns
Turn-on rise time	t _r				20.8		
Turn-off delay time	t _{d(off)}				84		
Turn-off fall time	t _f				52		
Drain-Source Diode Characteristics							
Drain-source diode forward voltage	V _{SD} ^④	V _{GS} =0V, I _S =10A				1.3	V
Continuous drain-source diode forward current	I _S ^①					28	A
Pulsed drain-source diode forward current	I _{SM} ^②					112	A

Notes:

1. $T_C = 25^\circ\text{C}$ Limited only by maximum temperature allowed.

2. $P_W \leq 10\mu s$, Duty cycle $\leq 1\%$.

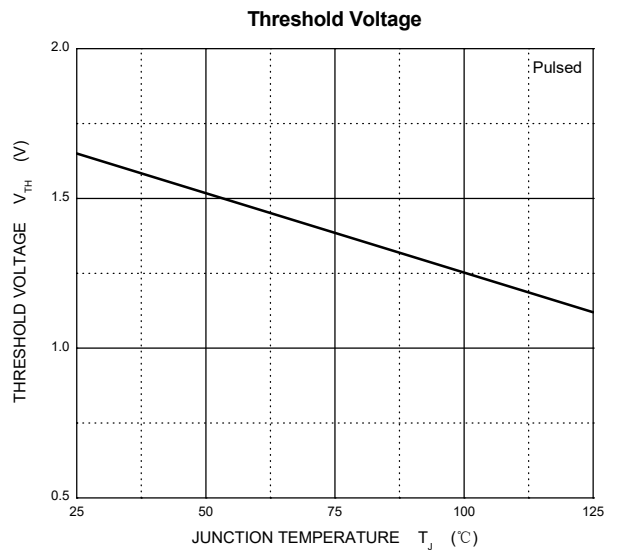
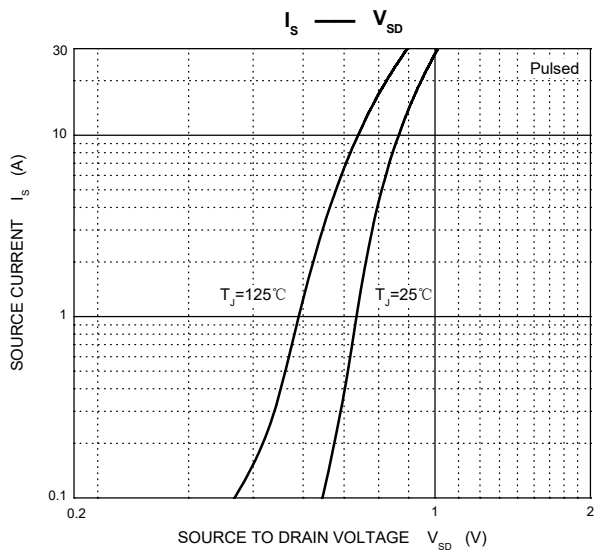
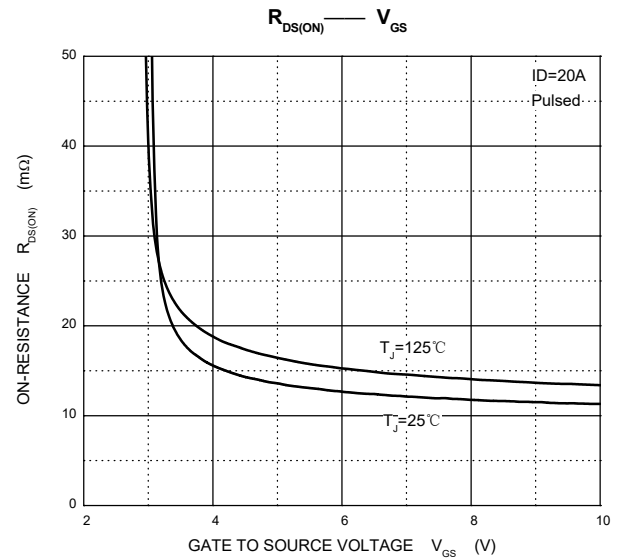
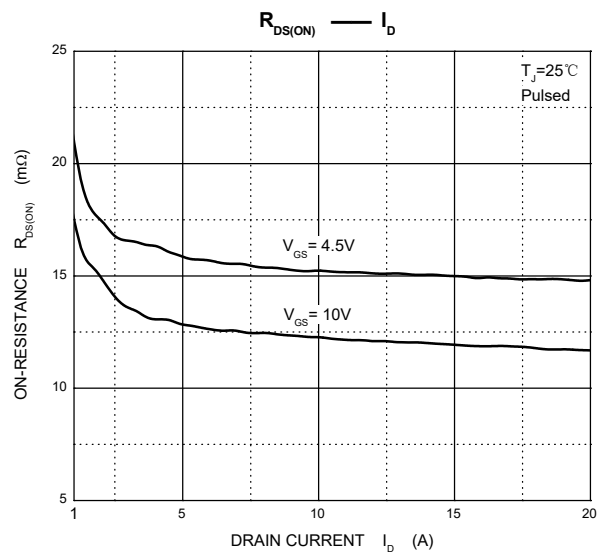
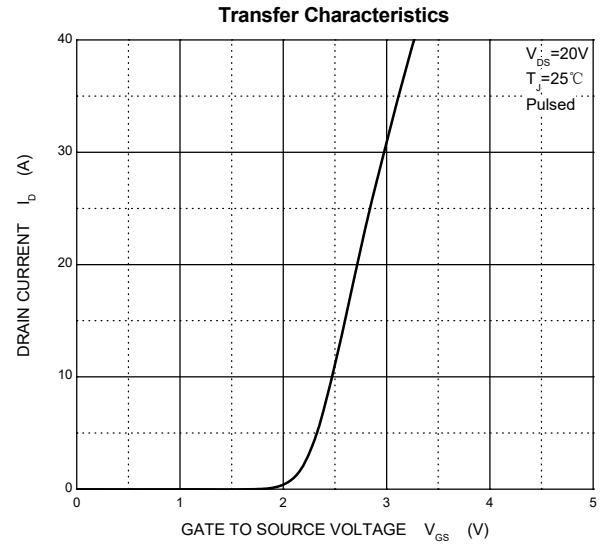
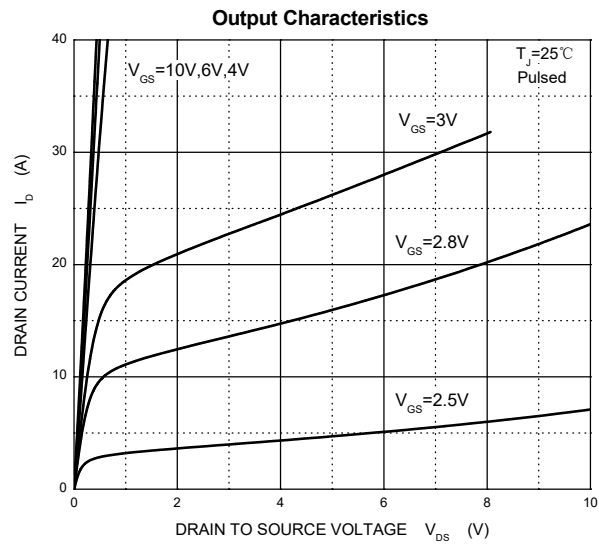
3. EAS condition: $V_{DD} = 30V, V_{GS} = 10V, L = 0.5mH, R_g = 25\Omega$ Starting $T_J = 25^\circ\text{C}$.

4. Pulse Test : Pulse Width $\leq 300\mu s$, duty cycle $\leq 2\%$.

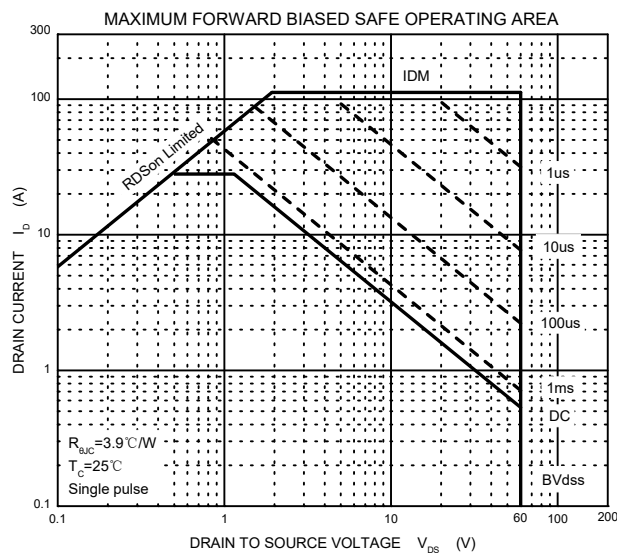
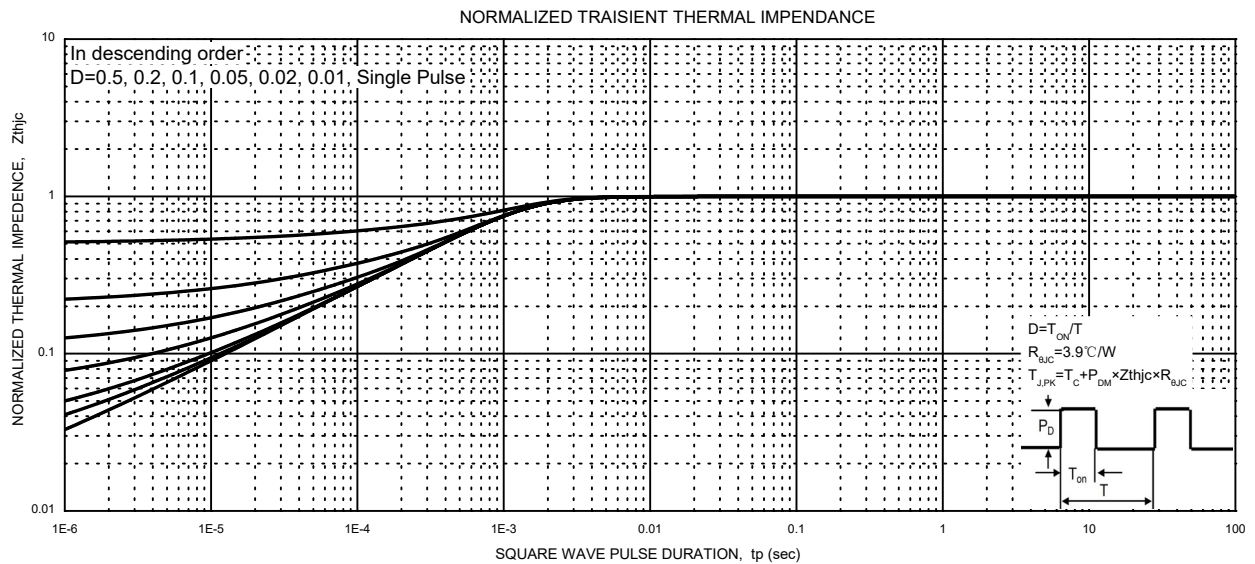
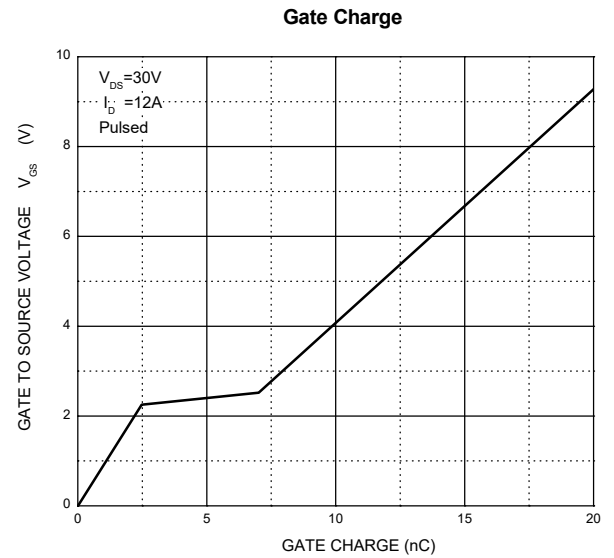
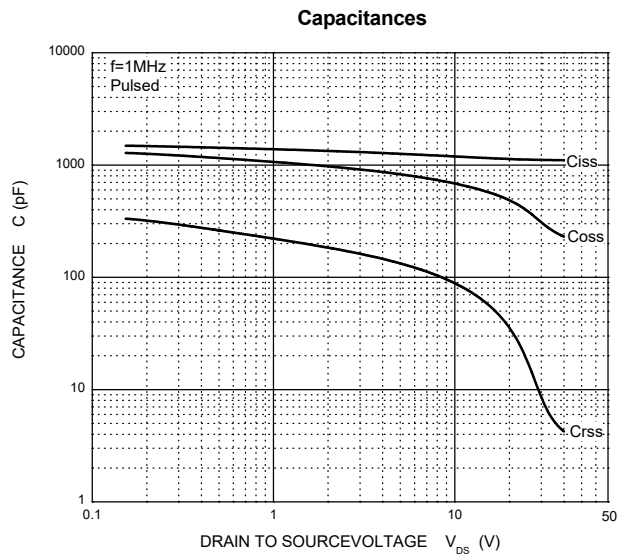
5. Guaranteed by design, not subject to production.

6. The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_a = 25^\circ\text{C}$.

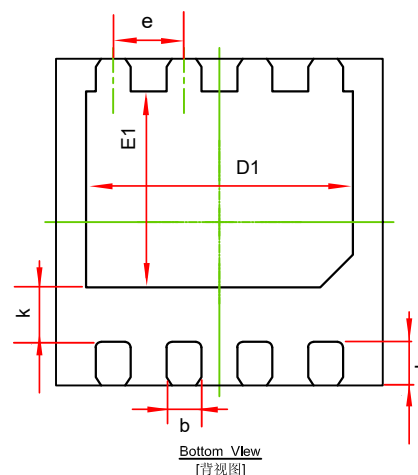
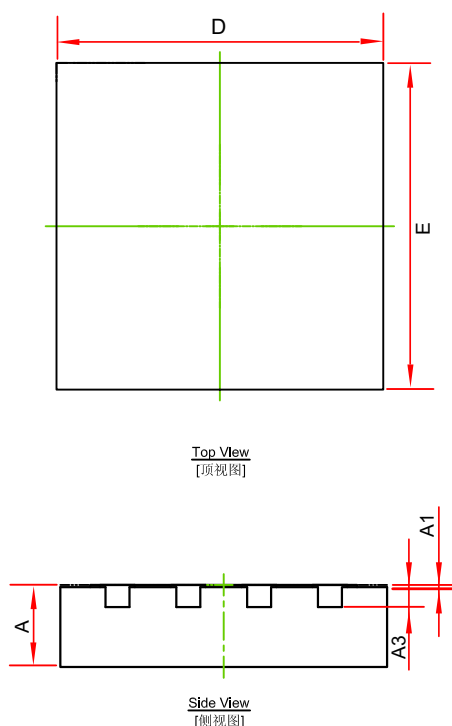
Typical Characteristics



Typical Characteristics

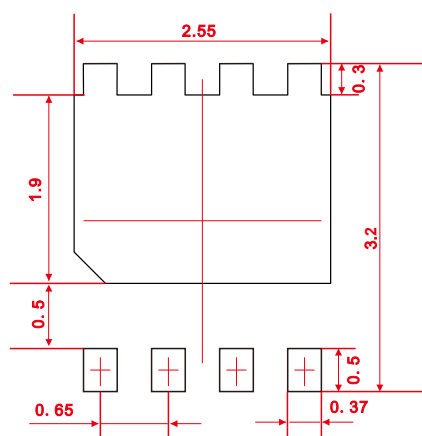


DFNWB3×3-8L Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A3	0.203 REF.		0.008 REF.	
D	2.924	3.076	0.115	0.121
E	2.924	3.076	0.115	0.121
D1	2.350	2.550	0.093	0.100
E1	1.700	1.900	0.067	0.075
k	0.200 MIN.		0.008 MIN.	
b	0.270	0.370	0.011	0.015
e	0.650 TYP.		0.026 TYP.	
L	0.300	0.500	0.012	0.020

DFNWB3×3-8L Suggested Pad Layout



Note:

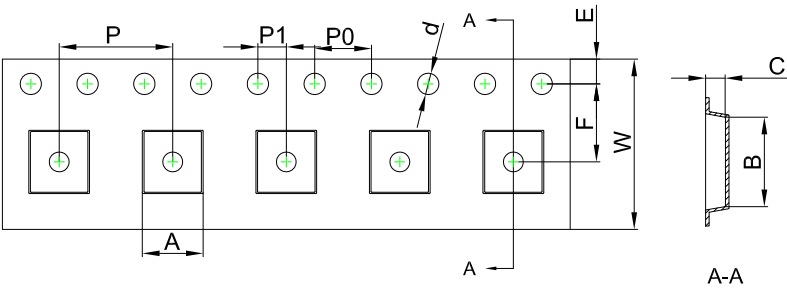
- 1.Controlling dimension:in millimeters.
2.General tolerance:±0.05mm.
3.The pad layout is for reference purposes only.

NOTICE

JSCJ reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. JSCJ does not assume any liability arising out of the application or use of any product described herein.

DFNWB3×3-8L Tape and Reel

DFNWB3×3-8L Embossed Carrier Tape

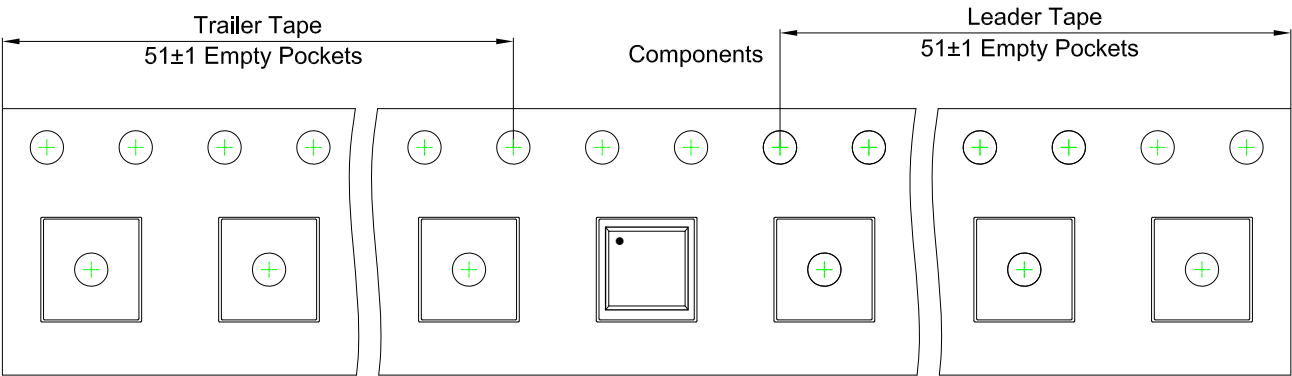


Packaging Description:

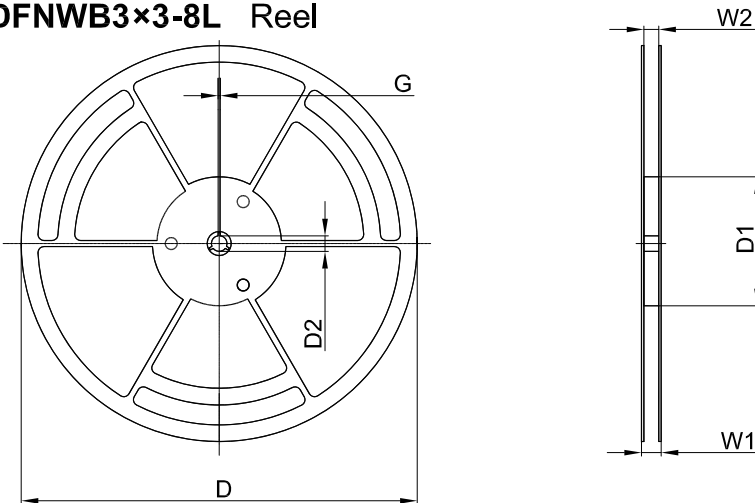
DFNWB3x3-8L parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 5,000 units per 13" or 33.0 cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type	A	B	C	d	E	F	P0	P	P1	W
DFNWB3×3-8L	3.35	3.35	1.13	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00

DFNWB3×3-8L Tape Leader and Trailer



DFNWB3×3-8L Reel



Dimensions are in millimeter						
Reel Option	D	D1	D2	G	W1	W2
13"Dia	Ø330.00	100.00	13.00	1.90	17.60	12.40

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)
5,000 pcs	13 inch	10,000 pcs	360×360×65	50,000 pcs	378×358×382